

Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

IN THE CLAIMS

1 1. (currently amended) In an imprint lithography system, a A method of forming a
2 layer on a substrate, said method comprising:
3 forming a plurality of flowable regions on said substrate;
4 contacting said flowable regions with a plurality of imprint lithography molds
5 disposed on a template; and
6 solidifying said plurality of flowable regions.

1 2. (currently amended) The method as recited in claim 1, wherein forming further
2 includes forming said plurality of flowable regions as an integer multiple of said plurality
3 of imprint lithography molds.

1 3. (original) The method as recited in claim 1 further including spreading a material
2 in said plurality of flowable regions over said substrate while confining said material
3 associated with each of said plurality of flowable regions to an area.

1 4. (original) The method as recited in claim 1, wherein contacting further includes
2 flexing said template to conform to a topography of said substrate.

1 5. (original) The method as recited in claim 1, wherein solidifying further includes
2 applying electromagnetic activation energy to said plurality of flowable regions.

6. (currently amended) The method as recited in claim 1, wherein contacting further includes flexing said template at a region between adjacent molds of said plurality of imprint lithography molds.

7. (original) The method as recited in claim 1, wherein forming further includes forming said plurality of flowable regions concurrently.

8. (original) The method as recited in claim 1, wherein forming further includes forming each of said plurality of flowable regions to be spaced-apart from adjacent flowable regions of said plurality of flowable regions.

9. (currently amended) In an imprint lithography system, a A method of forming a layer on a an imprint lithography substrate, said method comprising:

forming a plurality of flowable regions on a surface of said imprint lithography substrate;

providing each of said plurality of flowable regions with a surface having a desired shape; and

solidifying said plurality of flowable regions.

10. (currently amended) The method as recited in claim 9, wherein providing further includes contacting said plurality of flowable regions with a plurality of imprint lithography molds disposed on a template.

11. (currently amended) The method as recited in claim 10, wherein forming further includes forming said plurality of flowable regions as an integer multiple of said plurality of imprint lithography molds.

12. (currently amended) The method as recited in claim 10, wherein contacting further includes flexing said template to conform to a topography of said imprint lithography substrate.

13. (original) The method as recited in claim 9, wherein solidifying further includes applying electromagnetic activation energy to said plurality of flowable regions.

14. (currently amended) The method as recited in claim 10, wherein contacting further includes flexing said template at a region between adjacent molds of said plurality of imprint lithography molds.

15. (original) The method as recited in claim 9 further including spreading a material in said plurality of flowable regions over said substrate while confining said material associated with each of said plurality of flowable regions to an area.

16. (currently amended) A method of forming a layer on a substrate, said method comprising:
forming a plurality of flowable regions on said substrate;
spreading a material in said plurality of flowable regions over said substrate while confining said material associated with each of said plurality of flowable regions to an area;
contacting said flowable regions with a plurality of imprint lithography molds disposed on a template; and
solidifying said plurality of flowable regions.

17. (currently amended) The method as recited in claim 16, wherein forming further includes forming said plurality of flowable regions as an integer multiple of said plurality of imprint lithography molds.

18. (original) The method as recited in claim 16, wherein contacting further includes flexing said template to conform to a topography of said substrate.

19. (original) The method as recited in claim 16, wherein solidifying further includes applying electromagnetic activation energy to said plurality of flowable regions.

1 20. (currently amended) The method as recited in claim 16, wherein contacting
2 further includes flexing said template at a region between adjacent molds of said plurality
3 of imprint lithography molds.

1 21. (new) The method as recited in claim 1, wherein subsequent to the solidifying
2 step, the substrate is populated by a plurality of physically separated imprinted layers
3 corresponding to the plurality of flowable regions.

1 22. (new) The method as recited in claim 9, wherein subsequent to the solidifying
2 step, the substrate is populated by a plurality of physically separated imprinted layers
3 corresponding to the plurality of flowable regions.

1 23. (new) The method as recited in claim 16, wherein subsequent to the solidifying
2 step, the substrate is populated by a plurality of physically separated imprinted layers
3 corresponding to the plurality of flowable regions.